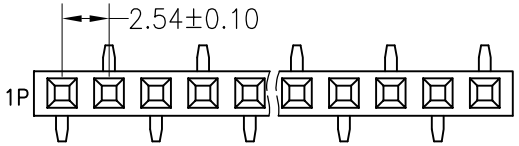
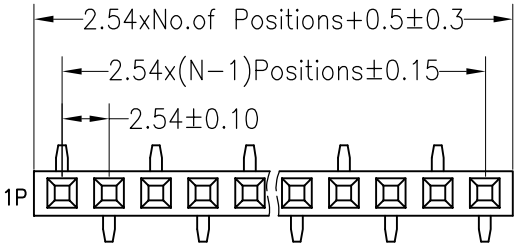
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

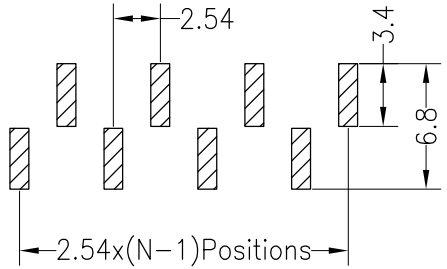


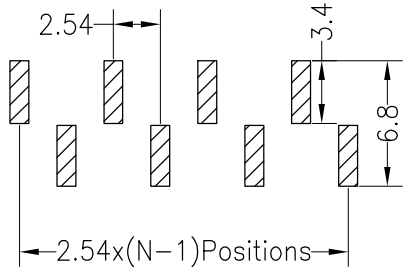
TYPE1



TYPE2

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

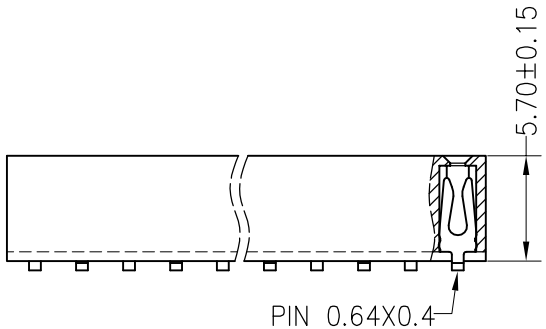


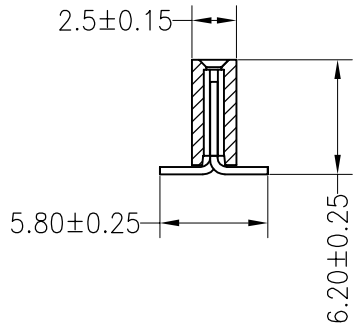


Ordering Information

2257 -01 XX X N XX M Y X 01(02)

- No.of Pins Per Row 1*40
- Insulator Material Option
  A=BK−PBT
  C=BK−PA6T
  D=BK−PA46
  D=BK−PA46
  F=BK−LCP
- Contact Plating
  G1:1U" Flash
  G2:1.5U" Gold
  G3:2U" Gold
  G4:3U" Gold
  G5:5U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- Packing
  P=Tube+Cap
  R=Reel+Cap





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	14.07.12
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	2257−01XXXNXXMYX01(2)
TITLE:	2.54PF H5.7mm 1xNpin SMT